

ANTREX Electronics

Electronic Components Sourcing Information

Product Reference Information

Part Number:	C1Q 1.25
Manufacturer:	Bel Fuse Inc.
Package:	Tape & Reel (TR), Cut Tape (CT), Digi-Reel®
Availability:	Please confirm with sales

Product Page:

<https://antrexco.com/product/details/bel-fuse-inc/c1q-1-25.html>

Request a Quote:

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Quality & Trust

New & Original Components

Supplier verification and packaging condition review

CoC / RoHS / REACH documents available on request

Secure sourcing support for OEM / EMS projects

Note:

This PDF includes an ANTREX product reference cover page.

The original manufacturer datasheet follows from the next page.

Type C1Q

Surface Mount Very Fast-Acting Chip Fuse

HF  C1Q Series – 1206 Size

RoHS Compliant

Features

- Fast Acting, Small size, 1206 SMD
- Current rating from 250mA to 7A
- Wide operating temperature range from -55°C to 125°C
- Tape and Reel for automatic SMD placement
- Compatible with 260°C IR Pb-free and wave soldering process
- Full compliance with EU Directive 2011/65/EU and amending directive 2015/863 (MSL = 1)
- Halogen Free, Lead Free
- AEC-Q Compliant
- Meets Bel automotive qualification*
- * - Largely based on internal AEC-Q test plan

Applications

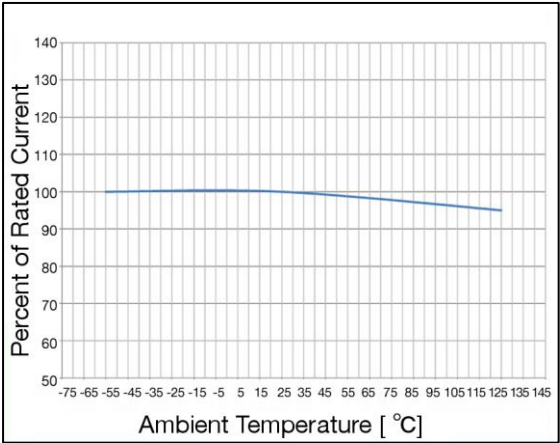
- Notebook
- LCD monitor
- PC computer
- Office electronic equipment
- Industrial equipment
- Medical equipment
- POE, POE+
- LCD / LED monitor
- Power supply
- LCD / LED TV
- DC-DC Converter



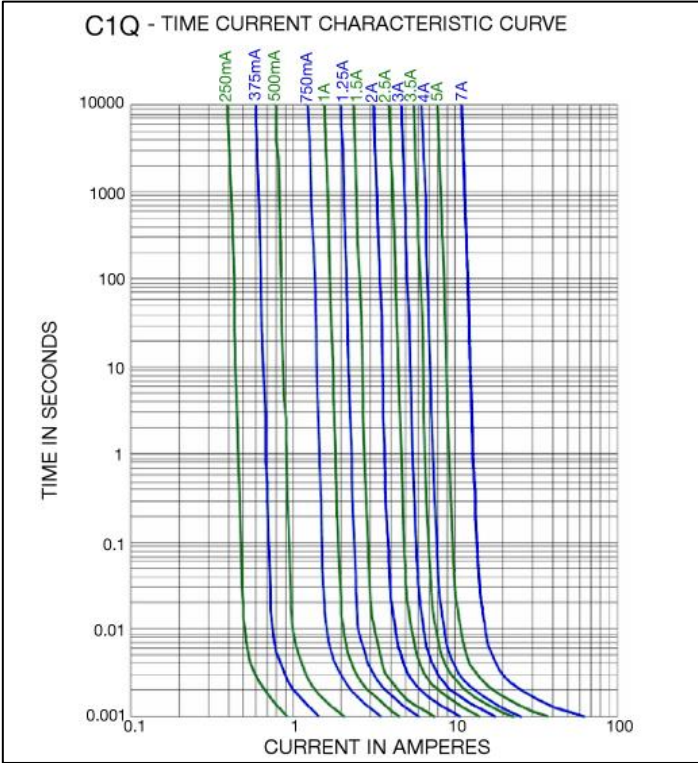
UK
CA                           

Type C1Q

Temperature Derating Curve



Average Time Current Curve



Electrical Specifications

Catalog Number	Ampere Rating (A)	Nominal Cold Resistance (ohms)	Nominal Volt-drop @100% In (Volt)	Voltage and Interrupting Ratings	Melting I²T @10 In (A² Sec)	Nominal Power Dissipation @100% In (W)	Agency Approvals		
									
C1Q 250	250mA	0.85	0.250	See Table of Safety Approvals on Page 1 for Voltage and associated Interrupting Ratings	0.00003	0.06	Y		Y
C1Q 375	375mA	0.48	0.222		0.00006	0.08	Y		Y
C1Q 500	500mA	0.32	0.195		0.00011	0.10	Y		Y
C1Q 750	750mA	0.175	0.163		0.00042	0.12	Y		Y
C1Q 1	1A	0.124	0.156		0.00096	0.16	Y		Y
C1Q 1.25	1.25A	0.092	0.149		0.0020	0.19	Y		Y
C1Q 1.5	1.5A	0.075	0.142		0.0024	0.21	Y		Y
C1Q 2	2A	0.054	0.140		0.005	0.28	Y		Y
C1Q 2.5	2.5A	0.042	0.138		0.008	0.35	Y		Y
C1Q 3	3A	0.035	0.136		0.020	0.41	Y		Y
C1Q 3.5	3.5A	0.030	0.140		0.029	0.49	Y		Y
C1Q 4	4A	0.028	0.144		0.038	0.58	Y		Y
C1Q 5	5A	0.022	0.154		0.075	0.77	Y		Y
C1Q 7	7A	0.015	0.160		0.116	1.12		Y	

Consult manufacturer for other ratings

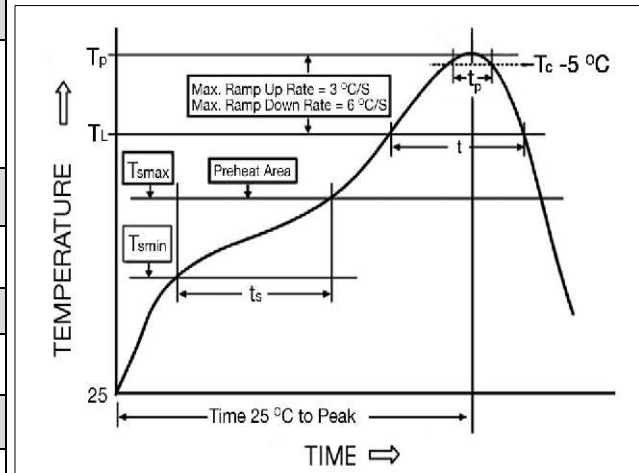
Environmental Specifications

Shock Resistance	MIL-STD-202G, Method 213B, Test Condition 1 (100 G's peak for 6 milliseconds; Sawtooth waveform)
Vibration Resistance	MIL-STD-202G, Method 201A (10-55 Hz, 0.06 inch, total excursion).
Salt Spray Resistance	MIL-STD-202G, Method 101E, Test Condition B (48 hrs.).
Insulation Resistance	MIL-STD-202G, Method 302, Test Condition A (After Opening) 10,000 ohms minimum.
Solderability	MIL-STD-202G, Method 208H
Resistance to solder Heat	MIL-STD-202G, Method 210F, Test Condition C. Top Side(260°C, 20 sec) MIL-STD-202G, Method 210F, Test Condition D. Bottom Side(260°C, 10 sec)
Thermal Shock	MIL-STD-202G, Method 107G, Test Condition B (-65°C to +125°C).
Operating Temperature	-55°C to +125°C
Moisture Sensitivity Level	1 (According to IPC J-Std-020)

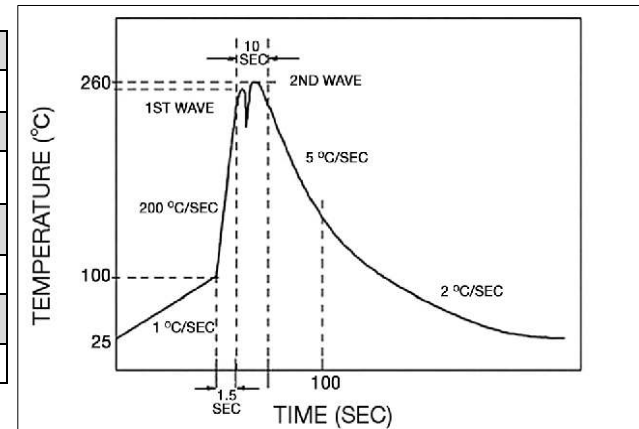
High temperature storage	MIL-STD-202 Method 108
Temperature cycling	JESD22 Method JA-104, Test Condition B
Biased humidity	MIL-STD-202 Method 103, 85°C/85% RH with 10% operating power for 1000 hrs.
Operational life	MIL-STD-202 Method 108, Test Condition D
Resistance to solvents	MIL-STD-202 Method 215
Mechanical shock	MIL-STD-202 Method 213, Test Condition C
Vibration	MIL-STD-202 Method 204
Resistance to soldering heat	MIL-STD-202 Method 210, Test condition B
Thermal shock	MIL-STD-202 Method 107
Solderability	J-STD-002
Board flex(SMD)	AEC-Q200-005
Terminal strength	AEC-Q200-006
Electrical characterization	3 temperature electrical

Soldering Parameters

IR Reflow Profile (IPC/JEDEC J-STD-020D)	
Preheat & Soak	
Temperature min (T _{min})	150°C
Temperature max (T _{max})	200°C
Time (T _{min} to T _{max}) (t _s)	60-120 seconds
Average ramp-up rate (T _{max} to T _p)	3°C/second max.
Liquidous temperature (T _L)	217°C
Time at liquidous (t _L)	60-150 seconds
Peak temperature (T _p)	260°C max
Time (t _p) within 5°C of the specified classification temperature (T _c)	30 seconds
Average ramp-down rate (T _p to T _{max})	6°C/second max.
Time 25°C to peak temperature	8 minutes max.



Lead-free Wave Soldering Profile	
Wave Soldering Parameter	
Average ramp-up rate	200°C / second
Heating rate during preheat	typical 1 - 2°C / second Max 4°C / second
Final preheat temperature	within 125°C of soldering temperature
Peak temperature Tp	260°C
Time within +0°C / -5°C of actual peak temperature	10 seconds
Ramp-down rate	5°C / second max.



Specifications subject to change without notice

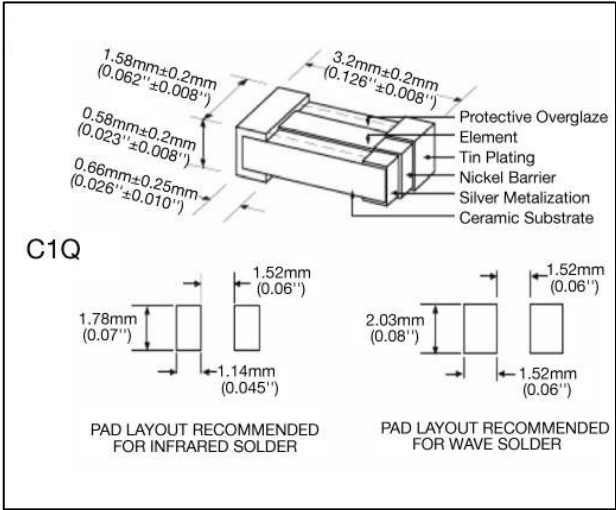
Type C1Q

Fuse FGNO Explanation
0685 - [XXXX] -XX
[XXXX]=Ampere Rating; XX=See Ordering Information as below

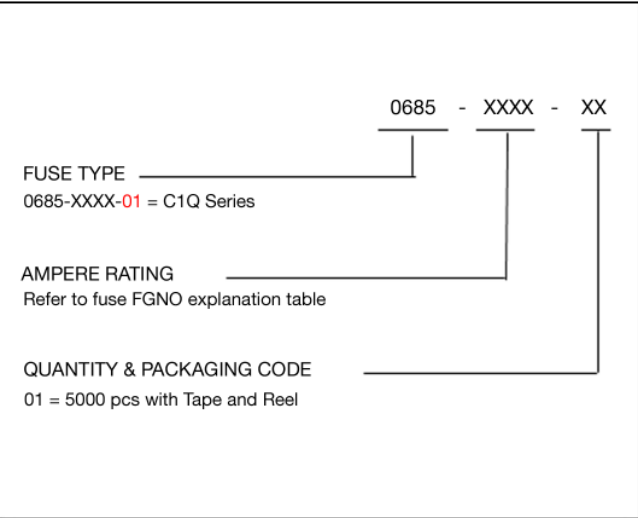
Fraction	Decimal	Milliamps	Bel FGNO[XXXX]
1/4	0.250	250	0250
3/8	.375	375	0375
1/2	.500	500	0500
3/4	.750	750	0750

Fraction	Decimal	Amps	Bel FGNO[XXXX]
	1.0	1	1000
1-1/4	1.25	1.25	1250
1-1/2	1.50	1.5	1500
	2.0	2	2000
2-1/2	2.5	2.5	2500
	3.0	3	3000
3-1/2	3.5	3.5	3500
	4.0	4	4000
	5.0	5	5000
	7.0	7	7000

Mechanical Dimensions



Ordering Information



Packaging

Packaging Tape & Reel	Packaging Specification	Quantity	Quantity & Packaging Code
8 mm wide tape with 7 inches Diameter reel	EIA Standard 481-E	5000	0685-XXXX-01